ON Semiconductor®



LCD and Camera EMI Filter Array with ESD Protection

CM1409

Features

- Six or eight channels of EMI filtering with integrated ESD protection
- Pi-style EMI filters in a capacitor-resistorcapacitor (C-R-C) network
- ±15kV ESD protection on each channel (IEC 61000-4-2 Level 4, contact discharge)
- ± 30kV ESD protection on each channel (HBM)
- Greater than -35dB attenuation (typical) at 1 GHz
- TDFN package with 0.50mm lead pitch:
 - 6-ch. = 12-lead TDFN
 - 8-ch. = 16-lead TDFN
- Tiny TDFN package size:
 - 12-lead: 3.0mm x 1.35mm
 - 16-lead: 4.0mm x 1.60mm
- Increased robustness against vertical impacts during manufacturing process
- RoHS-compliant, lead-free finishing

Applications

- LCD and Camera data lines in mobile handsets
- I/O port protection for mobile handsets, notebook computers, PDAs etc.
- EMI filtering for data ports in cell phones, PDAs or notebook computers.
- Wireless handsets
- Handheld PCs/PDAs
- LCD and camera modules

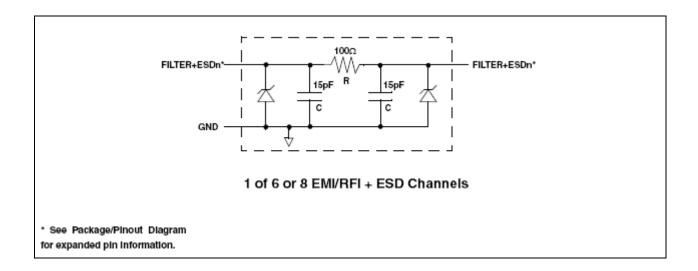
Product Description

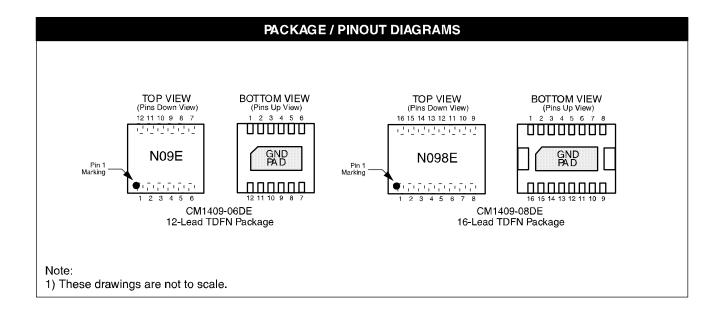
The CM1409 is a family of pi-style EMI filter arrays with ESD protection, which integrates either six or eight filters (C-R-C) in a small form factor, TDFN 0.50mm pitch package. The CM1409 has component values of $15pF-100\Omega-15pF$ per channel. The CM1409 has a cut-off frequency of 110MHz and can be used in applications with data rates up to 44Mbps. The parts include ESD diodes on every pin, which provide a very high level of protection for sensitive electronic components against electrostatic discharge (ESD). The ESD protected diodes safely dissipate ESD strikes of ±15kV, which even exceeds the of the IEC61000-4-2 maximum requirement international standard. Using the MIL-STD-883 (Method 3015) specification for Human Body Model (HBM) ESD, the pins are protected for contact discharges at greater than ±30kV.

These devices are particularly well-suited for portable electronics (e.g. wireless handsets, PDAs, notebook computers) because of their small package and easy-to-use pin assignments. In particular, the CM1409 is ideal for EMI filtering and protecting data and control lines for the I/O data ports, LCD display and camera interface in mobile handsets.

The CM1409 is housed in space-saving, low-profile 12- and 16-lead TDFN packages with a 0.50mm pitch, RoHS-compliant, lead-free finishing.

Block Diagram





	PIN DESCRIPTIONS										
	DEVICE PIN(s)			DEVICE PIN(s)							
-06	-08	NAME	DESCRIPTION	-06	-08	NAME	DESCRIPTION				
1	1	FILTER1	Filter + ESD Channel 1	12	16	FILTER1	Filter + ESD Channel 1				
2	2	FILTER2	Filter + ESD Channel 2	11	15	FILTER2	Filter + ESD Channel 2				
3	3	FILTER3	Filter + ESD Channel 3	10	14	FILTER3	Filter + ESD Channel 3				
4	4	FILTER4	Filter + ESD Channel 4	9	13	FILTER4	Filter + ESD Channel 4				
5	5	FILTER5	Filter + ESD Channel 5	8	12	FILTER5	Filter + ESD Channel 5				
6	6	FILTER6	Filter + ESD Channel 6	7	11	FILTER6	Filter + ESD Channel 6				
	7	FILTER7	Filter + ESD Channel 7		10	FILTER7	Filter + ESD Channel 7				
	8	FILTER8	Filter + ESD Channel 8		9	FILTER8	Filter + ESD Channel 8				
GNE	PAD	GND	Device Ground								

Ordering Information

PART NUMBERING INFORMATION							
Pins	Pins Package Lead-free Finish						
		Ordering Part Number ¹	Part Marking				
12	TDFN-12	CM1409-06DE	N09E				
16	TDFN-16	CM1409-08DE	N098E				

Note 1: Parts are shipped in Tape & Reel form unless otherwise specified.

CM1409

Specifications

ABSOLUTE MAXIMUM RATINGS						
PARAMETER	RATING	UNITS				
Storage Temperature Range	-65 to +150	°C				
DC Power per Resistor	100	mW				
DC Package Power Rating	500	mW				

STANDARD OPERATING CONDITIONS						
PARAMETER	RATING	UNITS				
Operating Temperature Range	-40 to +85	°C				

	ELECTRICAL OP	ERATING CHARACTERIS	STICS	(SEE NOTE	1)	
SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
R	Resistance		80	100	120	Ω
C _{TOTAL}	Total Channel Capacitance	At 2.5VDC Reverse Bias, 1MHz, 30mVAC	24	30	36	pF
С	Capacitance C ₁	At 2.5VDC Reverse Bias, 1MHz, 30mVAC		15		pF
V _{DIODE}	Standoff Voltage	I _{DIODE} =10μA		6.0		V
I _{LEAK}	Diode Leakage Current (reverse bias)	V _{DIODE} = 3.3V		0.1	1.0	μА
V _{SIG}	Signal Clamp Voltage Positive Clamp Negative Clamp	$I_{LOAD} = 10mA$ $I_{LOAD} = -10mA$	5.6 -1.5	6.8	9.0 -0.4	V V
V _{ESD}	In-system ESD Withstand Voltage a) Human Body Model, MIL-STD-883, Method 3015 b) Contact Discharge per IEC 61000-4- 2 Level 4	Note 2	±30 ±15			kV kV
R _{DYN}	Dynamic Resistance Positive Negative			2.3 0.9		Ω
f _c	Cut-off Frequency $Z_{\text{SOURCE}} = 50\Omega, Z_{\text{LOAD}} = 50\Omega$	Channel R = 100Ω , Channel C = $15pF$		110		MHz
A _{1GHz}	Absolute Attenuation @ 1GHz from 0dB Level	$Z_{\text{SOURCE}} = 50\Omega, Z_{\text{LOAD}} = 50\Omega,$ DC Bias = 0V; Notes 1 and 3		35		dB
A _{800MHz - 6GHz}	Absolute Attenuation @ 800MHz to 6GHz from 0dB Level	$Z_{\text{SOURCE}} = 50\Omega$, $Z_{\text{LOAD}} = 50\Omega$, DC Bias = 0V; Notes 1 and 3		30		dB

Note 1: $T_A=25$ °C unless otherwise specified.

Note 2: ESD applied to input and output pins with respect to GND, one at a time.

Note 3: Attenuation / RF curves characterized by a network analyzer using microprobes.

Performance Information

Typical Filter Performance (T_A=25°C, DC Bias=0V, 50 Ohm Environment)

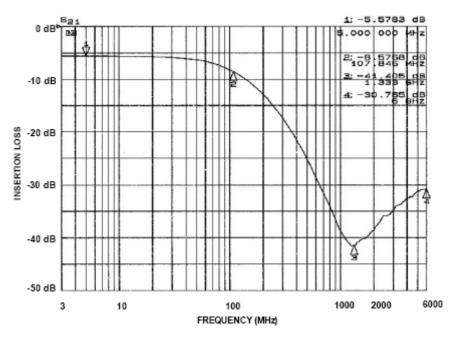


Figure 1. Insertion Loss vs. Frequency (FILTER1 Input to GND)

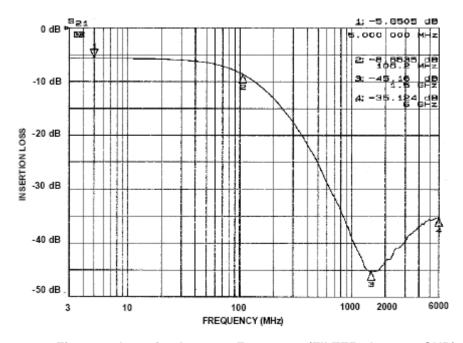


Figure 2. Insertion Loss vs. Frequency (FILTER2 Input to GND)

Performance Information (cont'd)

Typical Filter Performance (T_A=25°C, DC Bias=0V, 50 Ohm Environment)

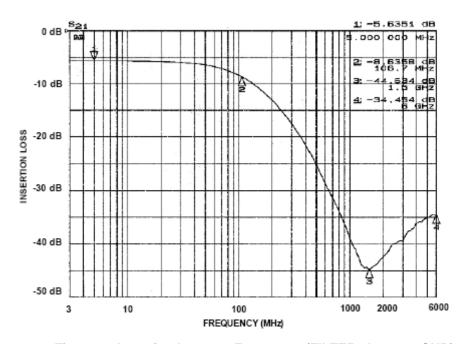


Figure 3. Insertion Loss vs. Frequency (FILTER3 Input to GND)

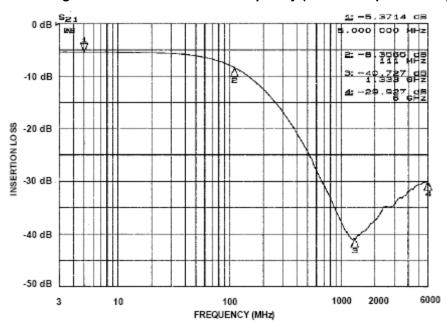


Figure 4. Insertion Loss vs. Frequency (FILTER4 Input to GND)

Performance Information (cont'd)

Typical Diode Capacitance vs. Input Voltage

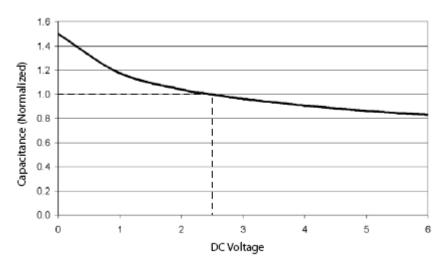


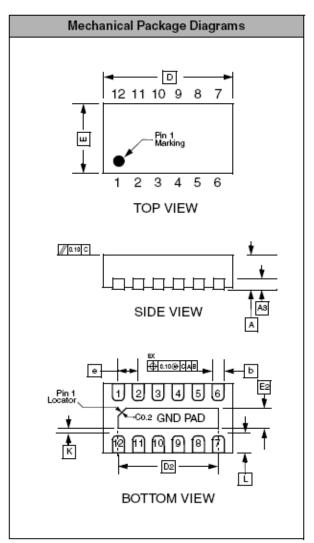
Figure 5. Filter Capacitance vs. Input Voltage (normalized to capacitance at 2.5VDC and 25°C)

Mechanical Details

TDFN-12 Mechanical Specifications

The CM1409-06DE is supplied in a 12-lead, 0.5mm pitch TDFN package. Dimensions are presented below.

PACKAGE DIMENSIONS									
Package	TDFN								
JEDEC No.			MO-	229C					
Leads			1	12					
Dim.	N	lillimete	rs		Inches				
Diiii.	Min	Nom	Max	Min	Nom	Max			
Α	0.70	0.75	0.80	0.028	0.030	0.031			
А3	•	0.20 RE	F	C	.008 RE	F			
b	0.20	0.25	0.30	0.008	0.010	0.012			
D	2.90	3.00	3.10	0.114	0.118	0.122			
D2	2.40	2.50	2.60	0.095 0.098		0.102			
E	1.25	1.35	1.45	0.049 0.053 0		0.057			
E2	0.35	0.40	0.45	0.014	0.016	0.018			
е	(0.50 BS	С	C	.020 BS	C			
к	0.20			0.008					
L	0.20	0.25	0.30	0.008	0.010	0.012			
# per tape and reel	3000 pieces								
	Controlling dimension: millimeters								

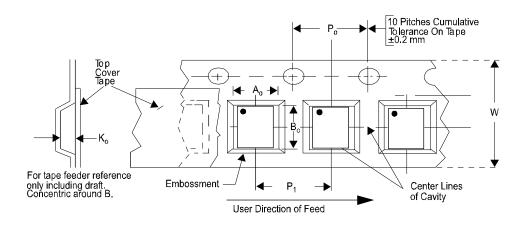


Dimensions for 12-Lead, 0.5mm pitch TDFN package

This package is compliant with JEDEC standard MO-229C with the exception of the "D", "D2", "E", "E2", "K" and "L" dimensions as called out in the table above.

Tape and Reel Specifications

PART NUMBER	PACKAGE SIZE (mm)	POCKET SIZE (mm) B _o X A _o X K _o	TAPE WIDTH W	REEL DIAMETER	QTY PER REEL	P _o	P,
CM1409-06DE	3.00 X 1.35 X 0.75	3.30 X 1.65 X 1.05	8mm	178mm (7")	3000	4mm	4mm

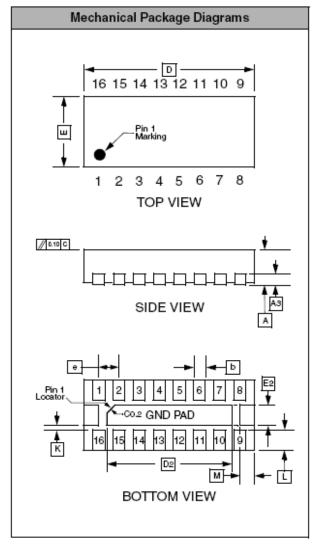


Mechanical Details (cont'd)

TDFN-16 Mechanical Specifications

The CM1409-08DE is supplied in a 16-lead, 0.5mm pitch TDFN package. Dimensions are presented below.

PACKAGE DIMENSIONS									
Package		TDFN							
JEDEC No.			MO-	229C					
Leads			1	16					
Dim.	M	lillimete	rs		Inches				
Diiii.	Min	Nom	Max	Min	Nom	Max			
Α	0.70	0.75	0.80	0.028	0.030	0.031			
А3	(0.20 RE	F	C	.008 RE	F			
b	0.20	0.25	0.30	0.008	0.008 0.010 0.0				
D	3.90	4.00	4.10	0.153	0.157	0.161			
D2	3.10	3.20	3.30	0.122	0.126	0.130			
E	1.50	1.60	1.70	0.059	0.063	0.067			
E2	0.30	0.40	0.50	0.012	0.016	0.020			
е	(0.50 BS	С	(0.020 BS	SC			
к	0.20			0.008					
L	0.20	0.30	0.40	0.008	0.010	0.012			
М	0.25 REF 0.010 REF								
# per tape and reel	3000 pieces								
	Contro	olling din	nension:	millime	ters				

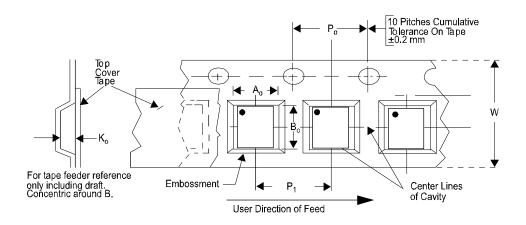


Dimensions for 16-Lead, 0.5mm pitch TDFN package

This package is compliant with JEDEC standard MO-229C with the exception of the "D", "D2", "E", "E2", "K" and "L" dimensions as called out in the table above.

Tape and Reel Specifications

PART NUMBER	PACKAGE SIZE (mm)	POCKET SIZE (mm) B _o X A _o X K _o	TAPE WIDTH W	REEL DIAMETER	QTY PER REEL	P _o	P,
CM1409-08DE	4.00 X 1.60 X 0.75	4.30 X 1.90 X 1.20	12mm	178mm (7")	3000	4mm	4mm



CM1409

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